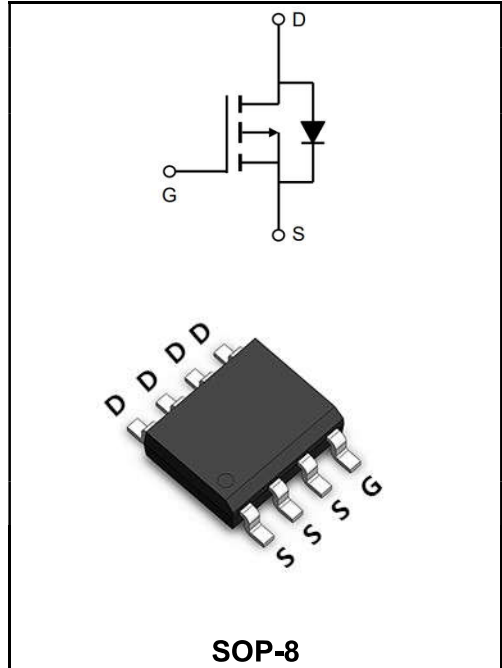


-30V P-CHANNEL ENHANCEMENT MODE MOSFET

MAIN CHARACTERISTICS

I_D	-9.3A
V_{DSS}	-30V
R_{DS(on)-typ}(@V_{GS}=-10V)	< 20mΩ(Type:16 mΩ)



Application

- ◆Lithium battery protection
- ◆Wireless impact
- ◆Mobile phone fast charging

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	-30	V
Gate - Source Voltage	V_{GS}	±20	V
Continuous Drain Current, V _{GS} @ -10V ¹ @T _A =25°C	I_D	-9.3	A
Continuous Drain Current, V _{GS} @ -10V ¹ @T _A =70°C	I_D	-7.0	A
Pulsed Drain Current ²	I_{DM}	-50	A
Total Power Dissipation ⁴ @T _A =25°C	P_D	3.1	W
Total Power Dissipation ⁴ @T _A =70°C	P_D	2	W
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C
Thermal Resistance Junction-Ambient ¹ (t≤10s)	R_{θJA}	33.8	°C/W
Thermal Resistance Junction to Case ¹	R_{θJC}	24	°C/W

Maximum Ratings at Tc=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	V(BR)DSS	-30	-33	-	V
Zero Gate Voltage Drain Current	$V_{DS}=-30V, V_{GS}=0V$	I_{DSS}	-	-	1	μA
Gate to Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	I_{GSS}	-	-	±100	nA
Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	V_{GS(th)}	-1.2	-1.5	-2.5	V
Static Drain-Source on-Resistance note3	$V_{GS}=-10V, I_D=-10A$	R_{DS(ON)}	-	16	20	mΩ
	$V_{GS}=-4.5V, I_D=-5A$		-	25	30	
Input Capacitance	$V_{DS}=-15V$ $V_{GS}=0V$ $f=1MHz$	C_{iss}	-	1550	-	pF
Output Capacitance		C_{oss}	-	327	-	
Reverse Transfer Capacitance		C_{rss}	-	278	-	
Total Gate Charge	$V_{DS}=-15V$ $V_{GS}=-10V$ $I_D=-9.1A$	Q_g	-	30	-	nC
Gate-Source Charge		Q_{gs}	-	5.3	-	
Gate-Drain("Miller") Charge		Q_{gd}	-	7.6	-	
Turn-on delay time	$V_{DD}=-15V$ $V_{GS}=-10V$ $I_D=-6A$ $R_{GEN}=2.5\Omega$	t_{d(on)}	-	14	-	ns
Turn-on Rise Time		T_r	-	20	-	
Turn-Off Delay Time		t_{d(OFF)}	-	95	-	
Turn-Off Fall Time		t_f	-	65	-	
Maximum Continuous Drain to Source Diode Forward Current		I_S	-	-	-10	A
Maximum Pulsed Drain to Source Diode Forward Current		I_{SM}	-	-	-40	A
Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S=-11A$	V_{SD}	-	-0.8	-1.2	V

Note :

- 1、 The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、 The data tested by pulsed , pulse width $\cong 300\mu s$, duty cycle $\cong 2\%$
- 3、 The EAS data shows Max. rating . The test condition is $V_{DD}=-25V, V_{GS}=-10V, L=0.1mH, I_{AS}=-5A$
- 4、 The power dissipation is limited by 150°C junction temperature
- 5、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

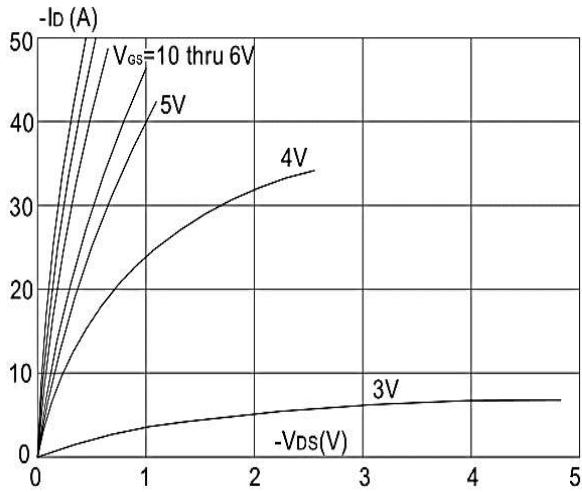


Figure 1: Output Characteristics

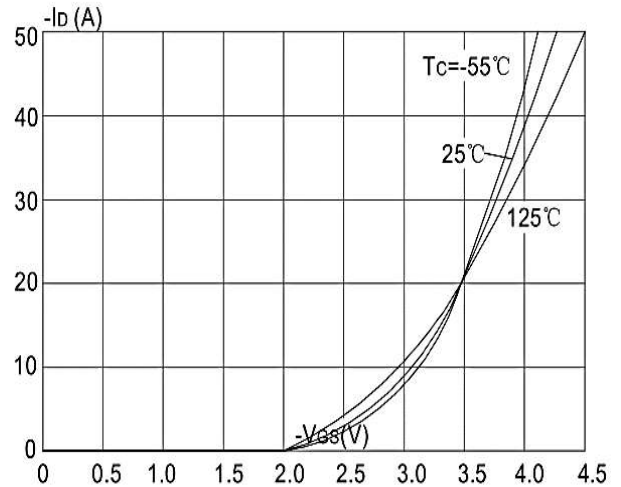


Figure 2: Typical Transfer Characteristics

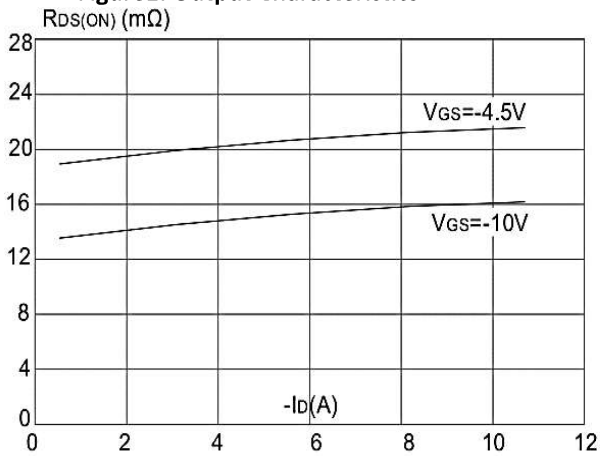


Figure 3: On-resistance vs. Drain Current

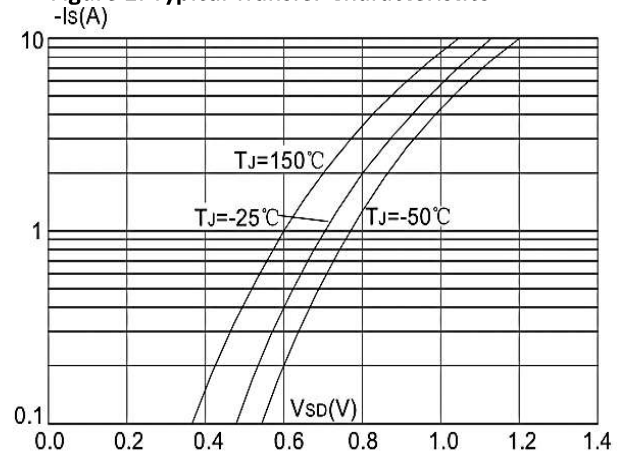


Figure 4: Body Diode Characteristics

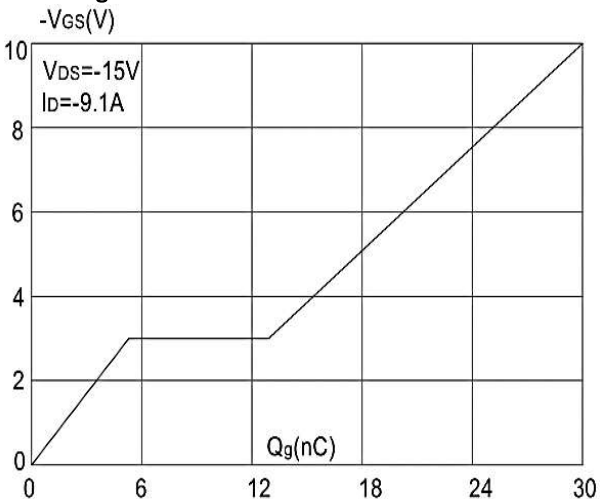


Figure 5: Gate Charge Characteristics

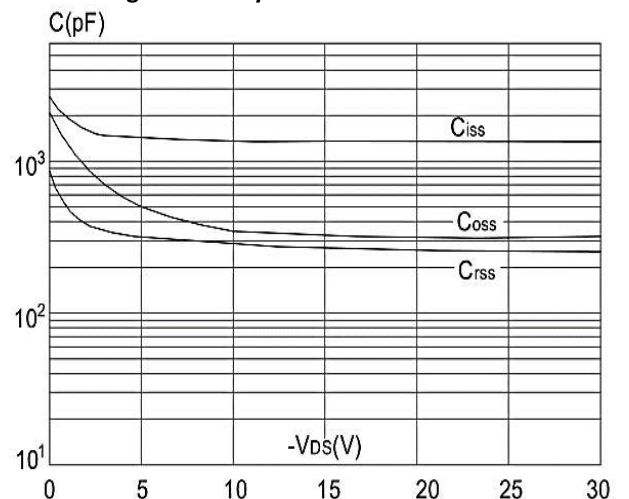


Figure 6: Capacitance Characteristics

Ratings and Characteristic Curves

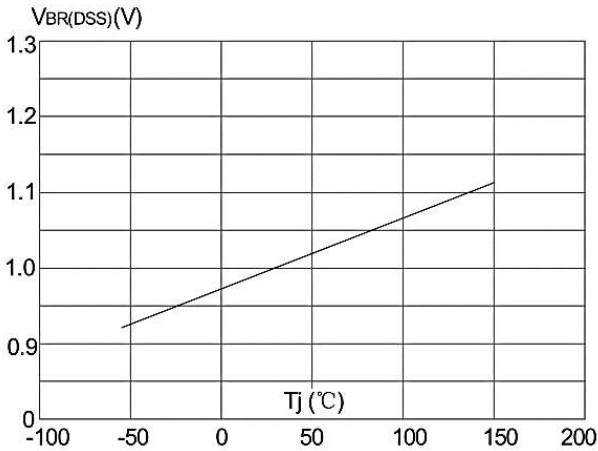


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

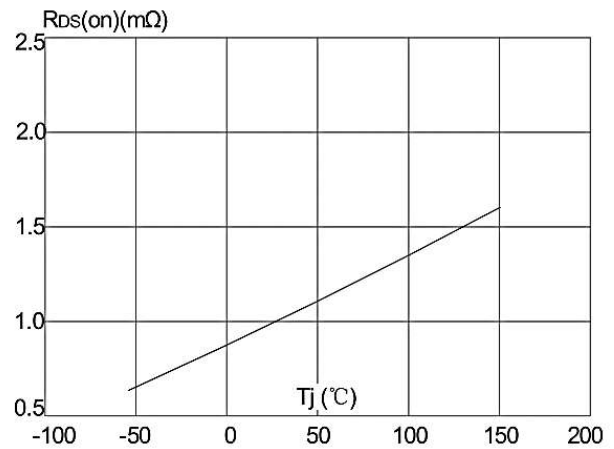


Figure 8: Normalized on Resistance vs. Junction Temperature

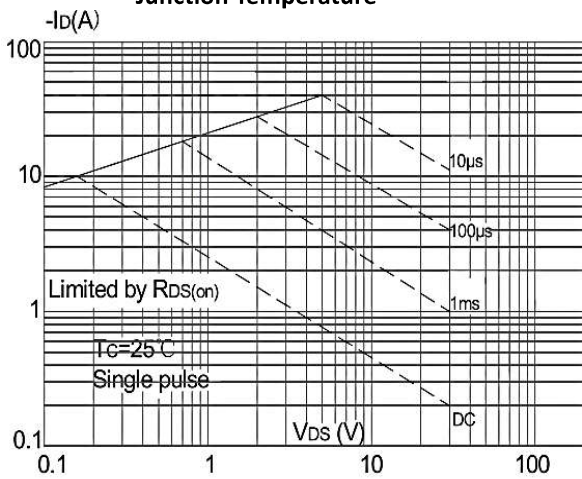


Figure 9: Maximum Safe Operating Area

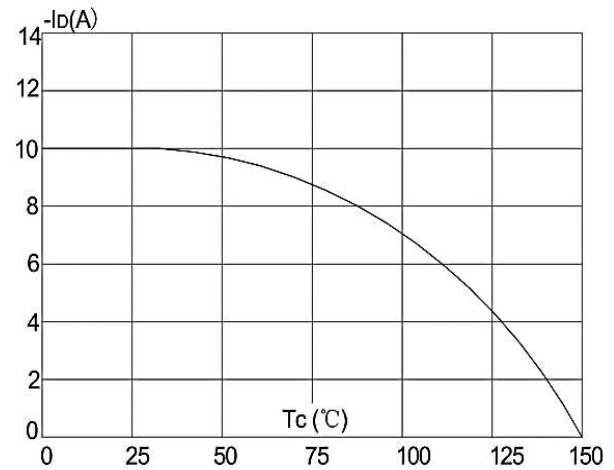


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

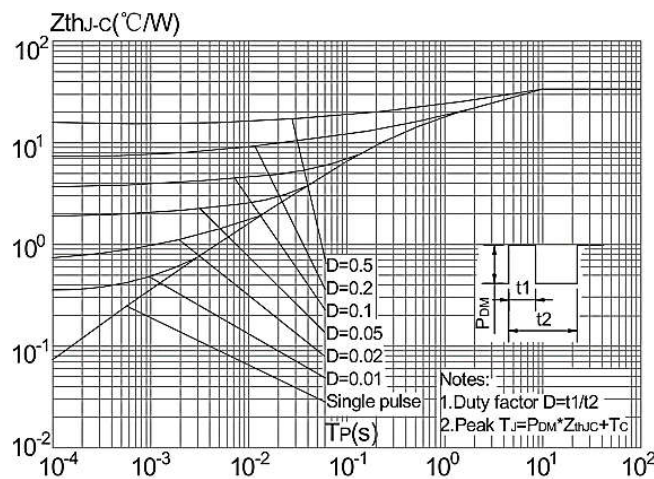
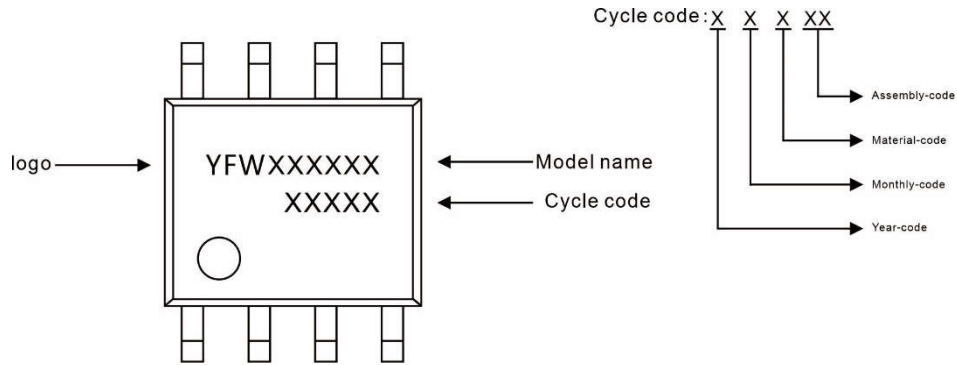


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

Marking Diagram



Ordering information

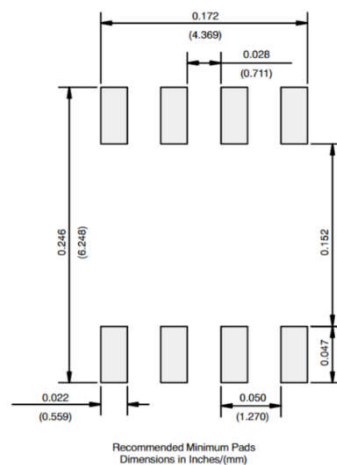
Package	Packing Description	Packing Quantity
SOP-8	Tape/Reel, 13" reel	3000PCS/Reel 30000PCS/Carton

Package Dimensions

SOP-8

Dim	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.35	1.50	0.053	0.059
b	0.35	0.55	0.014	0.022
c	0.15	0.25	0.006	0.010
D	4.80	5.00	0.189	0.197
D1	3.10	3.50	0.122	0.138
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
E2	2.20	2.60	0.087	0.102
e	1.27 (BSC)		0.050 (BSC)	
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°

The recommended mounting pad size



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